

ILLINOIS ENGINEERING INITIATIVE SCHOLARSHIP

IEI/PEPPY MOLDOVAN MEMORIAL AWARD \$1000

Applicants must be female engineering students currently enrolled as a sophomore* at one of the following colleges or universities.

- Illinois Central College, Peoria
- Kaskaskia Community College, Centralia
- Rend Lake Community College, Ina
- Bradley University, Peoria
- Southern Illinois University, Carbondale
- Southern Illinois University, Edwardsville
- University of Illinois, Urbana/Champaign

The scholarship is contingent upon recipient's enrollment and acceptance in an engineering program accredited by the Engineering Accreditation Board for Engineering and Technology (ABET) at one of the following universities:

- Bradley University, Peoria
- Southern Illinois University, Carbondale
- Southern Illinois University, Edwardsville
- University of Illinois, Urbana/Champaign
- University of Illinois, Chicago

DEADLINE FOR APPLICATION: April 1 annually

**Illinois Engineering Initiative
100 East Washington Street
Springfield, IL 62701
217-544-7424 Phone
217-528-6545 Fax
www.ilengineeringinitiative.org**

*Unless otherwise defined by the university where the applicant will attend, she shall have earned at least 30, but not more than 60, credit hours at the conclusion of the current semester.

IEI/Peppy Moldovan Memorial Award Application

Name _____

Permanent Home Address _____

Telephone _____

Email Address _____

Present Address if different from above _____

Telephone _____

ACADEMIC INFORMATION

SECONDARY SCHOOLS ATTENDED

Dates of Attendance

COLLEGES/UNIVERSITIES ATTENDED

Dates of Attendance

What engineering discipline are you studying? _____

I authorize my school officials to give information about my academic records to the ISPE Foundation. ___Yes ___No

To the best of my knowledge, the information presented on this application is complete and true.

Signature of Applicant

Date

According to the Family Educational Rights and Privacy Act, a transcript is a confidential document and cannot be released to a third party without the written consent of the student. So that we may distribute copies of your transcript along with your scholarship application to our Scholarship Committee, please sign the following permission statement.

I hereby grant permission to allow the ISPE Foundation to release information contained in this application, including copies of my transcript and supporting documents, to the ISPE Scholarship Committee.

Signature of Applicant

Date

Name

PROVIDE THE FOLLOWING SUPPORTING INFORMATION

TRANSCRIPTS: Submit official transcripts of all college and university work.

WORK EXPERIENCE:

Provide a record of your work experience, including any co-op programs.
List employer, dates of employment, and your duties.

ORGANIZATIONS, SOCIETIES, CLUBS AND ACTIVITIES:

Provide a list of your memberships and activities, both technical and non-technical, including years active and offices held since you entered college.

HONORS AND SCHOLARSHIPS:

Provide a list of any special honors and scholarships you have received, either in or out of school, since you entered college.

LETTERS OF RECOMMENDATION:

Submit two letters of recommendation:
(a) from the department chair or department faculty member.
(b) from past employer or other character reference.

ESSAY:

Prepare a essay of no more than 500 words, double spaced, discussing your interest in engineering, your major area of study and area of specialization, and the occupation you propose to pursue after graduation. What are your long-term goals and how do you hope to achieve them? The essay may also include any other information that is relevant to your career plans. Include your name and major field of engineering at the top of the page.

Assemble the application in the following order. Do not use a report binder.

- 1. Application**
- 2. Work Experience**
- 3. Organizations, Societies, Clubs and Activities**
- 4. Honors and Scholarships**
- 5. Faculty/Other Letters of Recommendation**
- 6. Essay (maximum 500 words)**
- 7. Official Transcripts**

Submit complete application with all supporting information required to:

Illinois Engineering Initiative
100 East Washington Street
Springfield, IL 62701

Or e-mail a PDF to Info@Iengineeringinitiative.org

**IT IS THE RESPONSIBILITY OF THE APPLICANT TO SEE THAT COMPLETE INFORMATION IS SUBMITTED AS REQUIRED.
INCOMPLETE APPLICATIONS WILL NOT BE CONSIDERED.**

DEADLINE: April 1 annually